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Winbond Bus Termination Regulator W83310U W83310UG



<u>W83310U</u>

Data Sheet Revision History

	PAGES	DATES	VERSION	VERSION ON WEB	MAIN CONTENTS
1.		03/Mar.	0.5	N.A.	All versions before 0.5 are for internal use only
2.		04/Feb.	0.51	N.A.	Add the thermal data inside
3		05/Mar.	0.6	N.A	Update the package dimension data.
4		06/Jan.	0.7	N.A	Add pb-free part no:W83310UG

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LIFE SUPPORT APPLICATIONS

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1. GENERAL DESCRIPTION

The W83310U is a linear regulator which provides achieves continuous 2.0 Amp bi-directional sinking and driving capability for DDR SDRAM bus terminator application. The chip simply implement a stable power supply which can track half of input power dynamically for bus terminator with a single chip; that is the chip integrates two power MOSFETs. There is no any external power device needed. The W83310U is promoted with TO252 power package. With W83310U design, a high integration, high performance, and cost-effective solution is promoted.

2. FEATURES

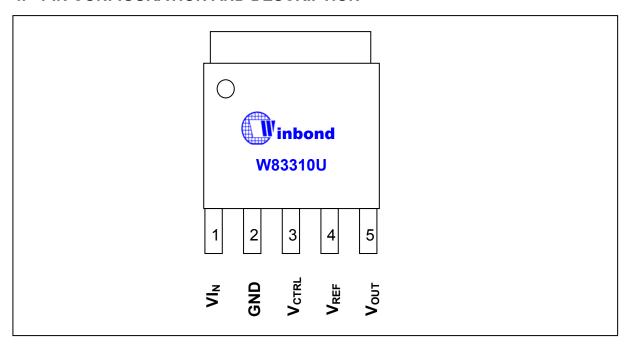
- Regulates a bi-directional power with driving and sinking capability
- Provides achieve continuous 2.0Amp driving and sinking current
- Power MOSFET integrated
- Low external component count
- Low output voltage offset
- Operates with +3.3V and +2.5V control power
- Power package TO252-5L
- Low cost and easy to use

3. APPLICATIONS

- DDR and DDR II Bus Termination Regulator
- Active Termination Bus
- SSTL-2
- SSTL-3



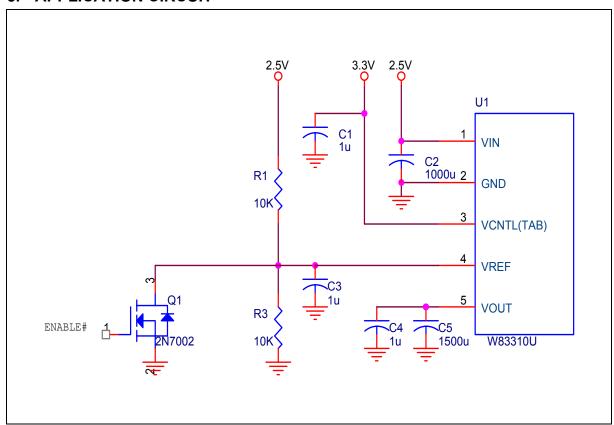
4. PIN CONFIGURATION AND DESCRIPTION



SYMBOL	PIN	FUNCTION	
VIN	1	Power input pin.	
GND	2	Ground.	
VCNTL	3	Gate drive voltage.	
VREF	4	Reference voltage and Chip enable.	
VOUT	5	Output voltage.	



5. APPLICATION CIRCUIT

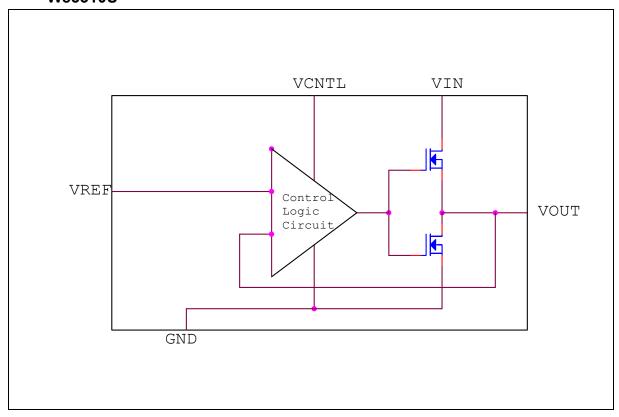


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6. INTERNAL BLOCK DIAGRAM

- W83310U





7. ELECTRICAL CHARACTERISTICS

7.1 AC CHARACTERISTICS

W83310U							
$VIN=2.5V, VCNTL=3.3V, VREF=1.25V, Cout=100uF, T_A=0$ °C to +70 °C							
PARAMETER	SYMBOL	MIN	TYP	MAX	UNITS	TEST CONDITIONS	
Output Offset Voltage	Vos	-5	0	+5	mV	I _{OUT} =0A	
			1.0			Loading: 0A→2.0A	
Load Regulation			1.0		%	Loading: 0A→- 2.0A	
Input Voltage Range	V _{IN}	1.62	2.5	3.63	V		
input voitage Nange	V _{CNTL}		3.3	3.63	V		
Operating Current of VCNTL	I _{CNTL}		0.5	1.0	mA	No Load(I _{OUT} =0A)	
Shutdown Threshold		0.8			V	Output=High	
Trigger				0.2	V	Output=Low	
Shutdown Current	I _{SHDN}	10	10		uA	VREF<0.2V	
Siluldowii Current				uA	Loading=0.7A		
Short Current Limit	I _{LMT}	4.0			Α		

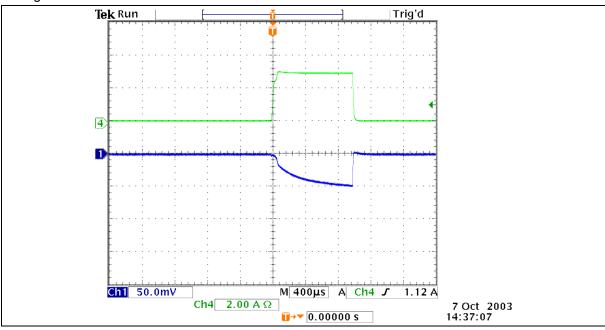
-5-

Note: Load regulation is tested with a 1ms duty pulse current and measuring V_{OUT}.

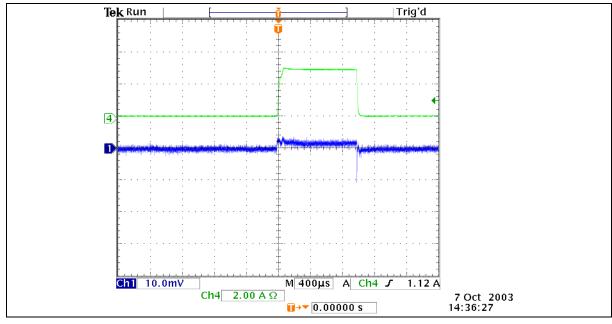


8. TYPICAL OPERATING WAVEFORM

-- Load regulation with test condition - V_{CTRL} =3.3V; V_{IN} =2.5V; V_{OUT} =1.25V; 3.0Amp 1ms duty pulse driving current. $\Delta V \approx 50 mV$.

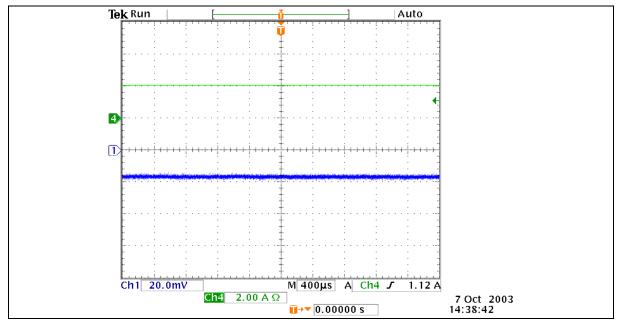


-- Load regulation with test condition - V_{CTRL} =3.3V; V_{IN} =2.5V; V_{OUT} =1.25V; 3.0Amp 1ms duty pulse sinking current. $\Delta V \approx 5 mV$.

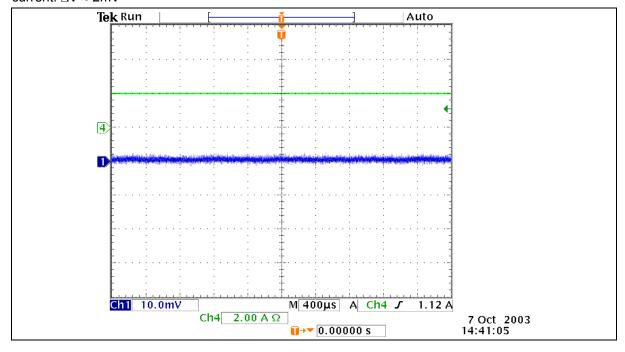




-- Load regulation with test condition - V_{CTRL} =3.3V; V_{IN} =2.5V; V_{OUT} =1.25V; 2.0Amp cont. driving current. $\Delta V \approx 20$ mV.



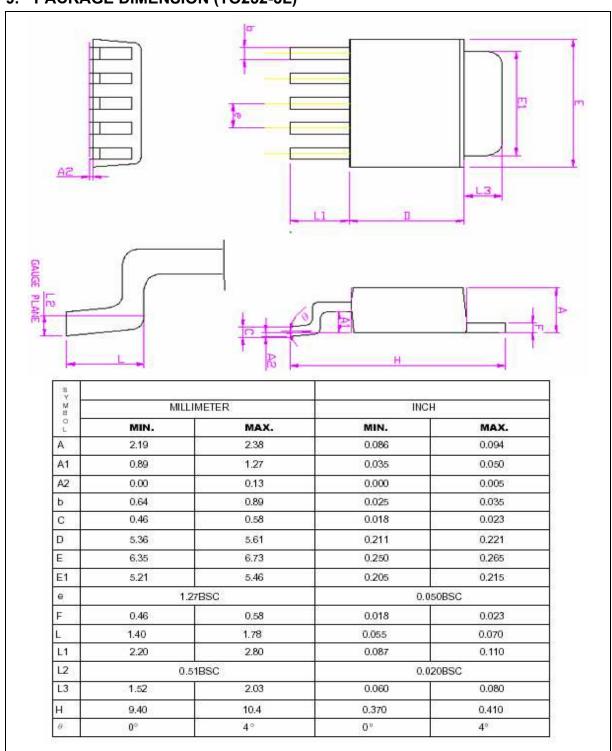
-- Load regulation with test condition - V_{CTRL} =3.3V; V_{IN} =2.5V; V_{OUT} =1.25V; 2.0Amp cont. sinking current. $\Delta V \approx 2mV$



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9. PACKAGE DIMENSION (TO252-5L)





10. THERMAL PERFORMANCE

Test on Four-Layer (2S2P) JEDEC Test Board							
Package	Power (W)		9 јс				
. uonago		Package	Die	Downset	Lead	Ambient	(°C /W)
TO-252-5L	3.18	96	145	79	78	25	15.5

11. ORDERING INFORMATION

PART NUMBER	PACKAGE TYPE	PRODUCTION FLOW		
W83310U	5L TO-252			

12. HOW TO READ THE TOP MARKING





Left line: Winbond logo

1st line: W83310U, W83310UG (Pb-free package) – the part number

2nd line: Tracking code Tracking code 316 G B

316: Packages assembled in Year 03', week 16

G: assembly house ID; O means OSE, G means GR, etc.

B: The IC version



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